#### MAX6006-MAX6009

# 1μA SOT23 Precision Shunt Voltage Reference

#### **General Description**

The MAX6006–MAX6009 ultra-low-power shunt references are ideal for space-critical and low-power applications. They are offered in 3-pin SOT23 packages, and the minimum operating current is guaranteed to be  $<1\mu$ A. The devices feature low temperature coefficients of <30ppm/°C and initial accuracy of better than 0.2%.

Available in +1.25V, +2.048V, +2.5V, and 3V output voltages, the MAX6006–MAX6009 have references of +1.25V, +2.048V, +2.5V, and +3.0V, respectively. The devices can be used as lower-power, higher-precision upgrades to the ICL8069, LM385, LT1004, and LM4040 references. The MAX6006–MAX6009 are available in two grades: A and B. The A grade features a temperature coefficient of 30ppm/°C over the extended temperature range of -40°C to +85°C, with an initial accuracy of 0.2%. Grade B features a temperature coefficient of 75ppm/°C with an initial accuracy of 0.5%. MAX6006 in +1.25V and MAX6008 in +2.5V are offered in 8-pin SO packages, as plug in upgrades for LT1004 and LM285.

#### **Features**

Ultra-Low Operating Current: Guaranteed < 1µA</li>

Small 3-Pin SOT23 PackageInitial Voltage Accuracy: 0.2%

Temperature Coefficient: 30ppm/°C max

• Temperature Range: -40°C to +85°C

Factory-Trimmed Output Voltages: +1.25V, +2.048V,

+2.5V, +3.0V

Wide Operating Range: 1µA to 2mA
 AEC-Q100 (MAX6008AEUR/V+ Only)

#### **Applications**

• Battery-Powered Equipment

Portable Meters

Precision Regulators

A/D and D/A Converters

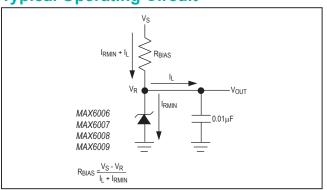
## **Ordering Information**

PART	OUTPUT VOLTAGE (V)	INITIAL ACCURACY (%)	TEMP COEFFICIENT (ppm/°C)	PIN-PACKAGE	TOP MARK
MAX6006AEUR+T	1.25	0.2	30	3 SOT23	+FZGH
MAX6006AESA+	1.25	0.2	30	8 SO	_
MAX6006BEUR+T	1.25	0.5	75	3 SOT23	+FZGI
MAX6006BESA+	1.25	0.5	75	8 SO	_
MAX6007AEUR+T	2.048	0.2	30	3 SOT23	+FZGK
MAX6007AESA+	2.048	0.2	30	8 SO	_

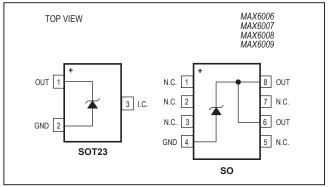
<sup>+</sup>Denotes a lead(Pb)-free/RoHS-compliant package.

Ordering Information continued at end of data sheet.

## **Typical Operating Circuit**



## **Pin Configurations**





T = Tape and reel.

# 1µA SOT23 Precision Shunt Voltage Reference

## **Absolute Maximum Ratings**

Operating Current (OUT to GND)20mA	Operating Temperature Range40°C to +85°C
Forward Current (GND to OUT)20mA	Storage Temperature Range65°C to +150°C
Continuous Power Dissipation (T <sub>A</sub> = +70°C)	Lead Temperature (soldering, 10s)+300°C
3-Pin SOT23 (derate 3.65mW/°C above +70°C)291.73mW	Soldering Temperature (reflow)+260°C
8-Pin SO (derate 7.4mW/°C above +70°C)588.2mW	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **Package Information**

#### 3 SOT23

PACKAGE CODE	U3+1				
Outline Number	<u>21-0051</u>				
Land Pattern Number	90-0179				
Thermal Resistance, Multilayer Board:					
Junction to Ambient (θ <sub>JA</sub> )	274.23°C/W				
Junction to Case $(\theta_{JC})$	86.19°C/W				

#### **8 SO**

PACKAGE CODE	S8+2
Outline Number	21-0041
Land Pattern Number	90-0096
Thermal Resistance, Multilayer Board:	
Junction to Ambient (θ <sub>JA</sub> )	136°C/W
Junction to Case (θ <sub>JC</sub> )	38°/W

For the latest package outline information and land patterns (footprints), go to <a href="www.maximintegrated.com/packages">www.maximintegrated.com/packages</a>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to <a href="https://www.maximintegrated.com/thermal-tutorial">www.maximintegrated.com/thermal-tutorial</a>.

#### **Electrical Characteristics—MAX6006**

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.) \text{ (Note 1)}$ 

PARAMETER	SYMBOL	CONE	DITIONS	MIN	TYP	MAX	UNITS
Devene Drackdown Voltons	V	T <sub>A</sub> = +25°C,	MAX6006A (0.2%)	1.2475	1.2500	1.2525	V
Reverse Breakdown Voltage	V <sub>R</sub>	I <sub>R</sub> = 1.2μA	MAX6006B (0.5%)	1.2438	1.2500	1.2563	V
Minimum Operating Current	I <sub>RMIN</sub>	$V_R$ change < 0.2% from $V_R$ at $I_R$ = 1.2 $\mu$ A			0.5	1.0	μA
Reverse Breakdown Change		$I_R = 1.2 \mu A \text{ to } 200 \mu A$	I <sub>R</sub> = 1.2μA to 200μA			1.0	mV
with Current		I <sub>R</sub> = 200μA to 2mA				2.0	IIIV
Reverse Dynamic Impedance		I <sub>R</sub> = 1.2μA to 2mA (Note 2)				1.5	Ω
Low-Frequency Noise		$I_R = 1.2\mu A, f = 0.1Hz$	$I_R = 1.2\mu A$ , $f = 0.1Hz$ to $10Hz$		30		μV <sub>P-P</sub>
Temperature Coefficient	TC	1 - 1 2 1	MAX6006A			30	/0C
(Note 3)	10	I <sub>R</sub> = 1.2μA	MAX6006B			75	ppm/°C
Long-Term Drift		1000h at T <sub>A</sub> = +25°C			150		ppm
Thermal Hysteresis (Note 4)					200		ppm

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#### **Electrical Characteristics—MAX6007**

( $T_A$  = -40°C to +85°C, unless otherwise noted. Typical values are at  $T_A$  = +25°C.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Reverse Breakdown Voltage	\/_	T <sub>A</sub> = +25°C, MAX6007A (0.2%		2.0439	2.048	2.0521	V
Reverse Breakdown Voltage	V <sub>R</sub>	I <sub>R</sub> = 1.2μA	MAX6007B (0.5%)	2.0378	2.048	2.0582	V
Minimum Operating Current	I <sub>RMIN</sub>	V <sub>R</sub> change < 0.2% from	$V_R$ change < 0.2% from $V_R$ at $I_R$ = 1.2 $\mu$ A		0.5	1.0	μA
Reverse Breakdown Change		$I_R = 1.2 \mu A \text{ to } 200 \mu A$	I <sub>R</sub> = 1.2μA to 200μA			1.3	mV
with Current		I <sub>R</sub> = 200μA to 2mA				2.3	""
Reverse Dynamic Impedance		$I_R = 1.2 \mu A \text{ to } 2 \text{mA (N)}$			1.8	Ω	
Low-Frequency Noise		$I_R = 1.2\mu A, f = 0.1Hz$	to 10Hz		50		μV <sub>P-P</sub>
Temperature Coefficient	TC	I_ = 1 2u A	MAX6007A			30	nnm/°C
(Note 3)	10	I <sub>R</sub> = 1.2μA	MAX6007B			75	ppm/°C
Long-Term Drift		1000h at T <sub>A</sub> = +25°C			150		ppm
Thermal Hysteresis (Note 4)					200		ppm

## **Electrical Characteristics—MAX6008**

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.) \text{ (Note 1)}$ 

PARAMETER	SYMBOL	CONDI	MIN	TYP	MAX	UNITS	
Reverse Breakdown Voltage	\/_	T <sub>A</sub> = +25°C,	MAX6008A (0.2%)	2.4950	2.5000	2.5050	V
Reverse Breakdown Voltage	V <sub>R</sub>	I <sub>R</sub> = 1.2μA	MAX6008B (0.5%)	2.4875	2.5000	2.5125	V
Minimum Operating Current	I <sub>RMIN</sub>	V <sub>R</sub> change < 0.2% fro	$V_R$ change < 0.2% from $V_R$ at $I_R$ = 1.2 $\mu$ A		0.5	1.0	μΑ
Reverse Breakdown Change		$I_R = 1.2 \mu A \text{ to } 200 \mu A$			1.5	mV	
with Current		$I_R = 200\mu A$ to 2mA			2.5	IIIV	
Reverse Dynamic Impedance		$I_R = 1.2 \mu A \text{ to } 2 \text{mA (N)}$	I <sub>R</sub> = 1.2μA to 2mA (Note 2)			2	Ω
Low-Frequency Noise		$I_R = 1.2\mu A, f = 0.1Hz$	to 10Hz		60		$\mu V_{P-P}$
Temperature Coefficient	тс	I_ = 1 2uA	MAX6008A			30	nnm/°C
(Note 3)	10	I <sub>R</sub> = 1.2μΑ	MAX6008B			75	ppm/°C
Long-Term Drift		1000h at T <sub>A</sub> = +25°C			150		ppm
Thermal Hysteresis (Note 4)					200		ppm

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#### **Electrical Characteristics—MAX6009**

 $(T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$  (Note 1)

PARAMETER	SYMBOL	CON	MIN	TYP	MAX	UNITS	
Reverse Breakdown Voltage	\ \/	T <sub>A</sub> = +25°C,	MAX6009A (0.2%)	2.9940	3.000	3.0060	V
Reverse breakdown voltage	V <sub>R</sub>	I <sub>R</sub> = 1.2μA	MAX6009B (0.5%)	2.9850	3.000	3.0150	V
Minimum Operating Current	I <sub>RMIN</sub>	V <sub>R</sub> change < 0.2% t	$V_R$ change < 0.2% from $V_R$ at $I_R$ = 1.2 $\mu$ A		0.5	1.0	μA
Reverse Breakdown Change		$I_R = 1.2 \mu A \text{ to } 200 \mu A$	I <sub>R</sub> = 1.2μA to 200μA			1.7	\/
with Current		I <sub>R</sub> = 200μA to 2mA				2.7	mV
Reverse Dynamic Impedance		$I_R = 1.2 \mu A \text{ to } 2 \text{mA} \text{ (}$	I <sub>R</sub> = 1.2μA to 2mA (Note 2)			2.2	Ω
Low-Frequency Noise		$I_R = 1.2\mu A, f = 0.1H$	z to 10Hz		75		μV <sub>P-P</sub>
Temperature Coefficient	TC	1 - 4 2 4	MAX6009A			30	nn=100
(Note 3)	10	l <sub>R</sub> = 1.2μΑ	MAX6009B			75	ppm/°C
Long-Term Drift		1000h at T <sub>A</sub> = +25°C			150		ppm
Thermal Hysteresis (Note 4)					200		ppm

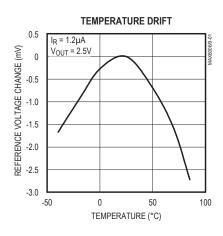
Note 1: All devices are 100% production tested at  $T_A = +25$ °C and are guaranteed by design for  $T_A = T_{MIN}$  to  $T_{MAX}$ , as specified.

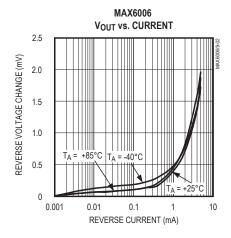
Note 2: This parameter is guaranteed by the "reverse breakdown change with current" test.

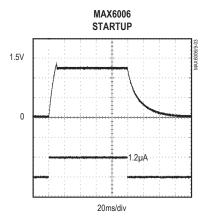
Note 3: TC is measured by the "box" method; i.e.,  $(V_{MAX} - V_{MIN})/(T_{MAX} - T_{MIN})$ . Note 4: Thermal hysteresis is defined as the change in the +25°C output voltage after cycling the device from  $T_{MIN}$  to  $T_{MAX}$ .

## **Typical Operating Characteristics**

 $(C_L = 0.01 \mu F, T_A = +25^{\circ}C, \text{ unless otherwise noted.})$ 

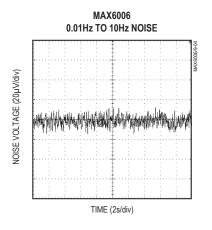


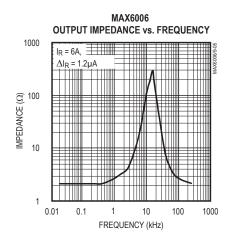


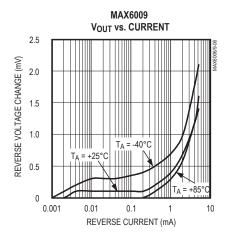


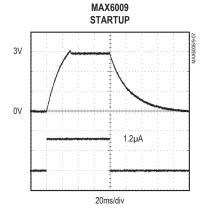
## **Typical Operating Characteristics (continued)**

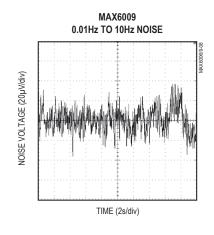
 $(C_L = 0.01 \mu F, T_A = +25^{\circ}C, \text{ unless otherwise noted.})$ 

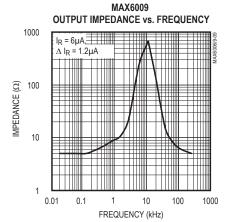












Pin [	<b>Descri</b>	ption
		P

Р	IN	NAME	FUNCTION			
SOT23	so	NAIVIE	FUNCTION			
1	6, 8	OUT	Output Voltage. Bias OUT with a pullup resistor to a potential greater than OUT. Bypass OUT to GND with a 0.01µF or larger capacitor.			
2	2 4 GND		Ground			
3	_	IC	Internally connected test point. Leave this pin unconnected, or connect to GND.			
_	1, 2, 3, 5, 7	N.C.	No connection. Not internally connected.			

## **Detailed Description**

The MAX6006–MAX6009 are precision, two-terminal, series bandgap voltage references. On-chip thin-film resistors are laser trimmed to provide 0.2% output voltage accuracies. Voltages of +1.25V, +2.048V, +2.5V, and +3.0V are available in the space-saving SOT23 package (2.1mm 5 2.7mm).

## **Applications Information**

#### **Output/Load Capacitance**

For devices in this family, OUT needs to be bypassed to GND with a  $0.01\mu F$  or larger capacitor. In applications where the load or the supply can experience step changes, additional capacitance will reduce the amount of overshoot (or undershoot) and assist the circuit's transient response.

#### **Output Voltage Hysteresis**

Output voltage hysteresis is the change in the output voltage at  $T_A$  = +25°C before and after the device is cycled over its entire operating temperature range. Hysteresis is caused by differential package stress appearing across the bandgap core transistors. The temperature hysteresis value is typically less than 200ppm.

#### **Turn-On Time**

The output capacitance and bias current of the MAX6006—MAX6009 greatly affects turn-on settling time. In the *Typical Operating Characteristics*, turn-on time is shown with a 10nF output capacitor and a 1.2µA bias current. Under these conditions, the MAX6006–MAX6009 settle in 40ms. Settling time will linearly decrease in proportion to the circuit's bias current.

## **Typical Applications**

In the typical shunt regulator application shown in Figure 1,  $R_{BIAS}$  is used to set the current through the load ( $I_L$ ) and the current through the shunt regulator ( $I_{RMIN}$ ). There are two worst-case situations that  $R_{BIAS}$  needs to be sized for:

- R<sub>BIAS</sub> must be small enough that when V<sub>S</sub> (supply voltage) is at its minimum and I<sub>L</sub> is at its maximum, I<sub>RMIN</sub> is equal to at least the minimum operating current of the shunt regulator.
- R<sub>BIAS</sub> must be large enough that when V<sub>S</sub> is at its maximum and I<sub>L</sub> is at its minimum, I<sub>RMIN</sub> is < 2mA.</li>

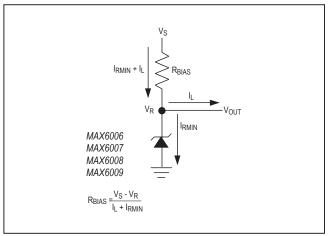


Figure 1. Typical Application Circuit

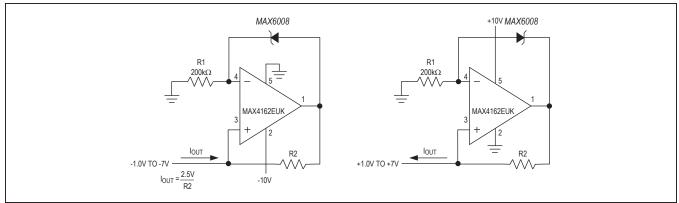


Figure 2. Precision 1µA to 1mA Current Sources

# **Ordering Information (continued)**

PART	OUTPUT VOLTAGE (V)	INITIAL ACCURACY (%)	TEMP COEFFICIENT (ppm/°C)	PIN-PACKAGE	TOP MARK
MAX6007BEUR+T	2.048	0.5	75	3 SOT23	+FZGL
MAX6007BESA+	2.048	0.5	75	8 SO	_
MAX6008AEUR+T	2.50	0.2	30	3 SOT23	+FZGN
MAX6008AEUR/V+T	2.50	0.2	30	3 SOT23	+FZWO
MAX6008AESA+	2.50	0.2	30	8 SO	_
MAX6008BEUR+T	2.50	0.5	75	3 SOT23	+FZGO
MAX6008BESA+	2.50	0.5	75	8 SO	_
MAX6009AEUR+T	3.00	0.2	30	3 SOT23	+FZGQ
MAX6009AESA+	3.00	0.2	30	8 SO	_
MAX6009BEUR+T	3.00	0.5	75	3 SOT23	+FZGR
MAX6009BESA+	3.00	0.5	75	8 SO	_

<sup>+</sup>Denotes a lead(Pb)-free/RoHS-compliant package.

# **Chip Information**

PROCESS: BiCMOS

<sup>/</sup>V denotes an automotive qualified part.
T = Tape and reel.

## MAX6006-MAX6009

# 1µA SOT23 Precision Shunt Voltage Reference

## **Revision History**

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	8/00	Initial release	_
1	7/12	Added /V to MAX6008 and updated Ordering Information.	7
2	9/17	Added AEC statement to Features section	1
3	8/19	Updated Typical Operating Characteristics	4, 5
4	11/19	Updated Absolute Maximum Ratings and added new Package Information section	2

For pricing, delivery, and ordering information, please visit Maxim Integrated's online storefront at https://www.maximintegrated.com/en/storefront/storefront.html.

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